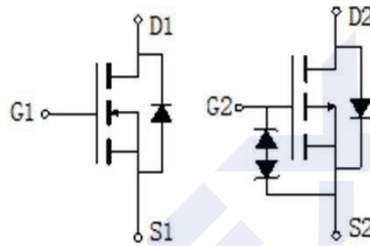
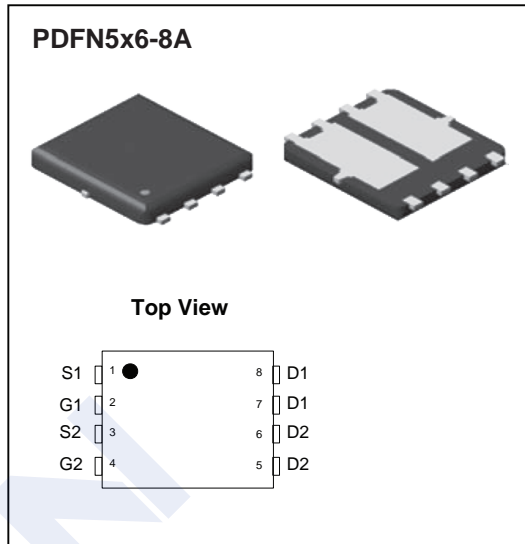


N-Ch and P-Ch MOSFET

2NP10

■ Features

- N-Channel
 - $V_{DS} = 40V$
 - $I_D = 40A$
 - $R_{DS(ON)} = 12m\Omega$ (Typ.) @ $V_{GS}=10V$
 - $R_{DS(ON)} = 17m\Omega$ (Typ.) @ $V_{GS}=4.5V$
- P-Channel
 - $V_{DS} = -40V$
 - $I_D = -40A$
 - $R_{DS(ON)} = 21m\Omega$ (Typ.) @ $V_{GS}=-10V$
 - $R_{DS(ON)} = 30m\Omega$ (Typ.) @ $V_{GS}=-4.5V$
- Fast Switching Speed
- ESD Protected
- Low gate Charge

■ Absolute Maximum Ratings ($T_a = 25^\circ C$ Unless otherwise specified)

Parameter		Symbol	N-Channel	P-Channel	Unit
Drain-Source Voltage		V_{DS}	40	-40	V
Gate-Source Voltage		V_{GS}	± 20	± 20	
Continuous Drain Current (Note 1)	$T_C=25^\circ C$	I_D	40	-40	A
	$T_C=100^\circ C$		25	-25	
Pulsed Drain Current (Note 2)		I_{DM}	160	-160	
Single Pulse Avalanche Energy (Note 3)		EAS	42	42	mJ
Maximum Power Dissipation (Note 4)		P_D	42	36	W
Thermal Resistance, Junction- to-Ambient (Note 1)		$R_{\theta JA}$	50		$^\circ C/W$
Thermal Resistance, Junction- to-Case (Note 1)		$R_{\theta JC}$	3	3.5	
Junction Temperature		T_J	150		$^\circ C$
Storage Temperature Range		T_{stg}	-55 to 150		

Notes 1. The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper.

2. The data tested by pulsed , pulse width $\leq 300\mu s$, duty cycle $\leq 2\%$.

3. The EAS data shows Max. rating . The test condition is $V_{DD}=25V, V_{GS}=10V, L=0.25mH, I_{AS}=17.8A$.

4. The power dissipation is limited by $150^\circ C$ junction temperature.

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■ Electrical Characteristics (T_a = 25°C Unless otherwise specified)

Parameter	Symbol	Test Conditions	Type	Min	Typ	Max	Unit	
Off Characteristics								
Drain-Source Breakdown Voltage	V _{BSS}	I _D =250μA, V _{GS} =0V	N-CH	40			V	
		I _D =-250μA, V _{GS} =0V	P-CH	-40				
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =40V, V _{GS} =0V	N-CH			1	μA	
		V _{DS} =40V, V _{GS} =0V, T _J =125°C				30		
		V _{DS} =-40V, V _{GS} =0V	P-CH			-1		
		V _{DS} =-40V, V _{GS} =0V, T _J =125°C				-30		
Gate-Body Leakage Current	I _{GSS}	V _{DS} =0V, V _{GS} =±20V	N-CH			±1		
		V _{DS} =0V, V _{GS} =±20V	P-CH			±10		
On Characteristics (Note 1)								
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} , I _D =250μA	N-CH	1		2.5	V	
		V _{DS} =V _{GS} , I _D =-250μA	P-CH	-1		-2.5		
Static Drain-Source On-Resistance	R _{DS(on)}	V _{GS} =10V, I _D =20A	N-CH		12	16	mΩ	
		V _{GS} =4.5V, I _D =16A			17	22		
		V _{GS} =-10V, I _D =-20A	P-CH		21	25		
		V _{GS} =-4.5V, I _D =-16A			30	35		
Forward Transconductance	g _{FS}	V _{DS} =5V, I _D =12A	N-CH		8		S	
		V _{DS} =-5V, I _D =-8A	P-CH		12.6			
Dynamic Characteristics (Note 2)								
Input Capacitance	C _{iss}	N-Channel: V _{GS} =0V, V _{DS} =20V, f=1MHz P-Channel: V _{GS} =0V, V _{DS} =-20V, f=1MHz	N-CH		880		pF	
			P-CH		1900			
Output Capacitance	C _{oss}		N-CH		170			
			P-CH		245			
Reverse Transfer Capacitance	C _{rss}		N-CH		70			
			P-CH		135			
Switching Characteristics (Note 2)								
Total Gate Charge	Q _g	N-Channel: V _{GS} =10V, V _{DS} =32V, I _D =20A P-Channel: V _{GS} =-10V, V _{DS} =-32V, I _D =-20A	N-CH		18		nC	
			P-CH		42			
Gate Source Charge	Q _{gs}		N-CH		6		ns	
			P-CH		9			
Gate Drain Charge	Q _{gd}		N-CH		5			
			P-CH		14			
Turn-On DelayTime	t _{d(on)}		N-Channel: V _{DD} =20V, I _{DS} =20A	N-CH		6		ns
			V _{GEN} =10V, R _G =4.7Ω	P-CH		15		
Turn-On Rise Time	t _r		N-Channel: V _{DD} =20V, I _{DS} =20A	N-CH		10		
		V _{GEN} =10V, R _G =4.7Ω	P-CH		43			
Turn-Off DelayTime	t _{d(off)}	P-Channel: V _{DD} =-20V, I _{DS} =20A	N-CH		24			
		V _{GEN} =-10V, R _G =4.7Ω	P-CH		24			
Turn-Off Fall Time	t _f	N-Channel: V _{DD} =20V, I _{DS} =20A	N-CH		5			
		V _{GEN} =-10V, R _G =4.7Ω	P-CH		14			
Drain-Source Diode Characteristics								
Diode Forward Voltage	V _{SD}	I _S =20A, V _{GS} =0V	N-CH			1.2	V	
		I _S =-20A, V _{GS} =0V	P-CH			1.3		

Notes 1. Pulse Test: Pulse Width ≤ 300μs, Duty Cycle ≤ 2%.

2. Guaranteed by design, not subject to production

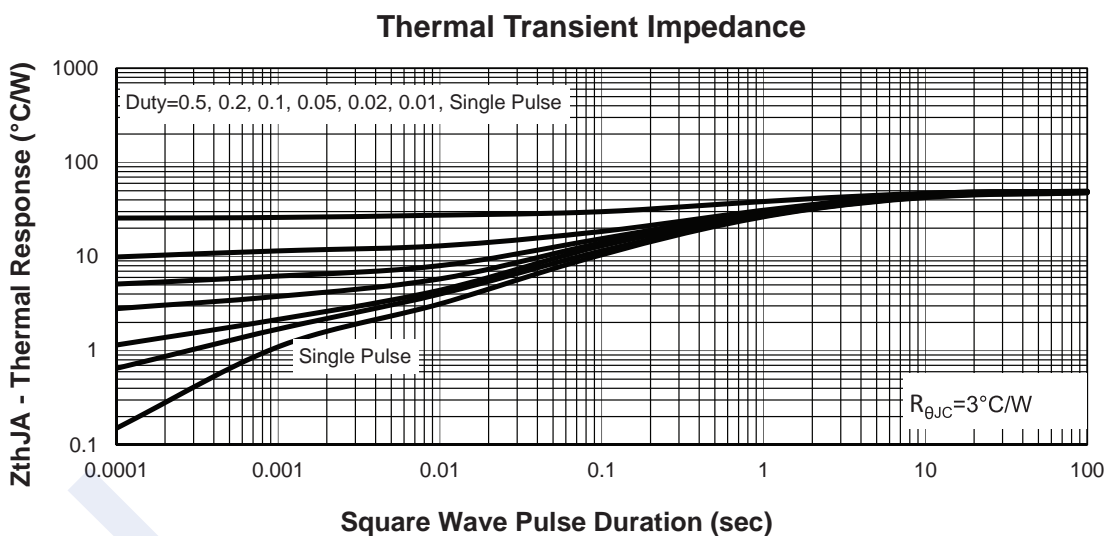
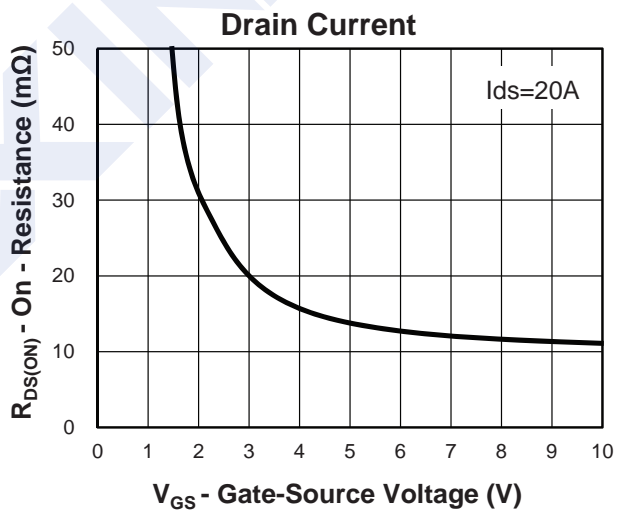
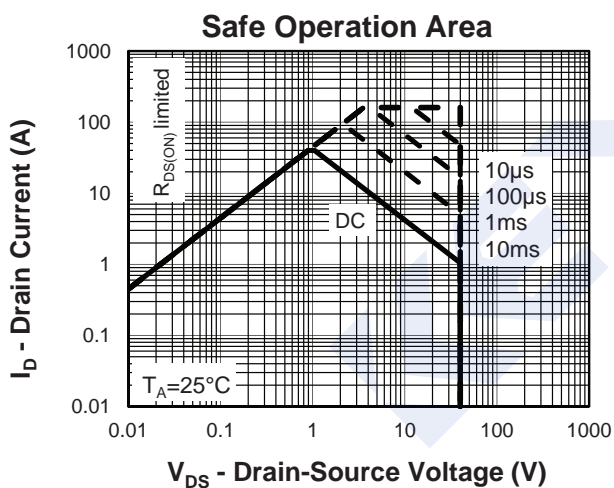
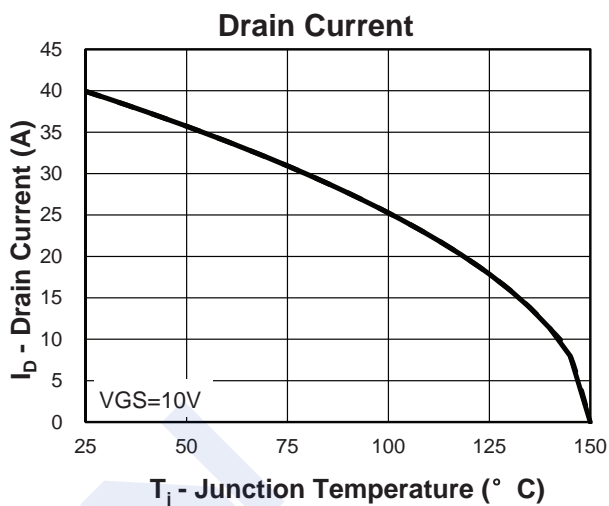
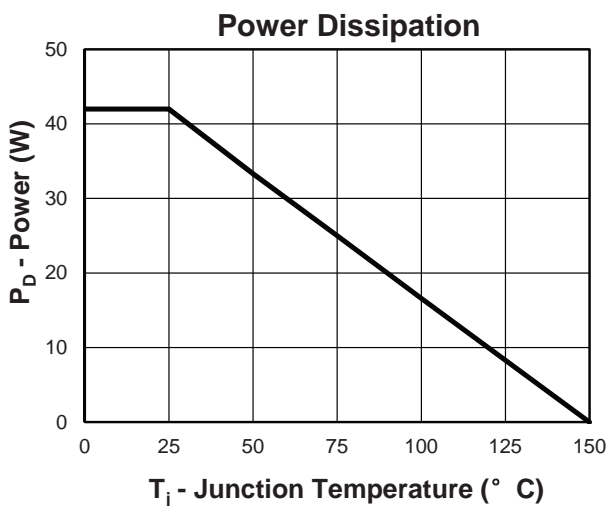
■ Marking

Marking	NP10 KA****
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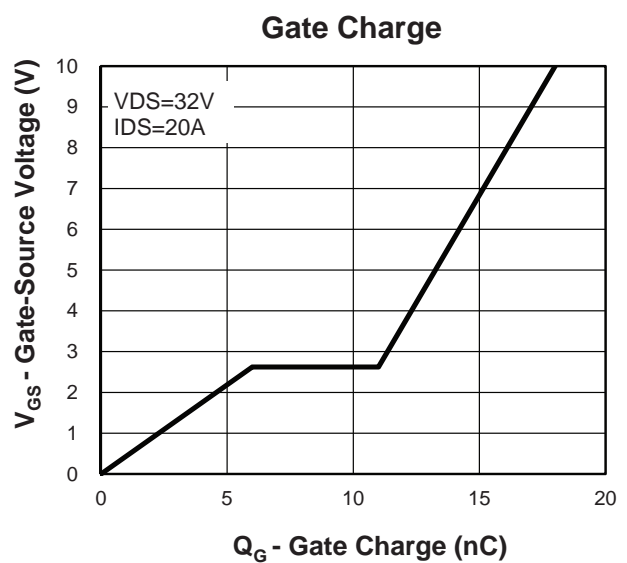
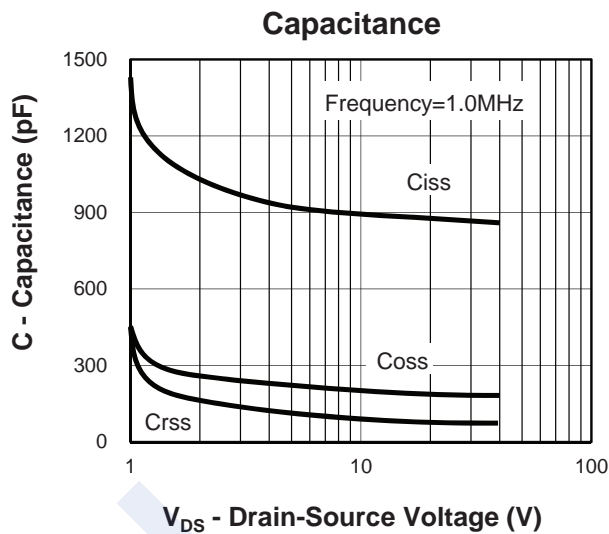
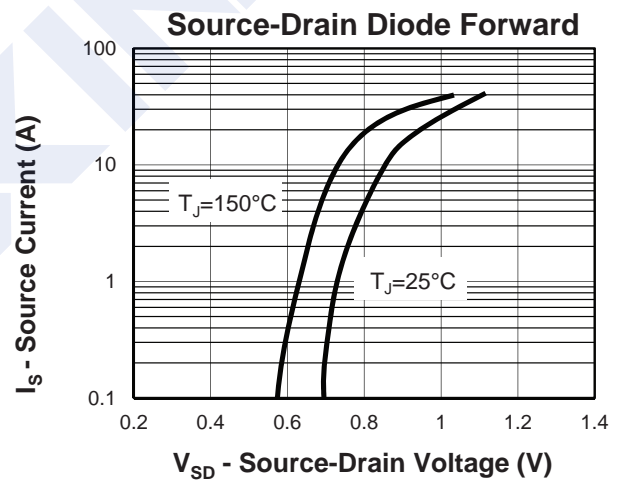
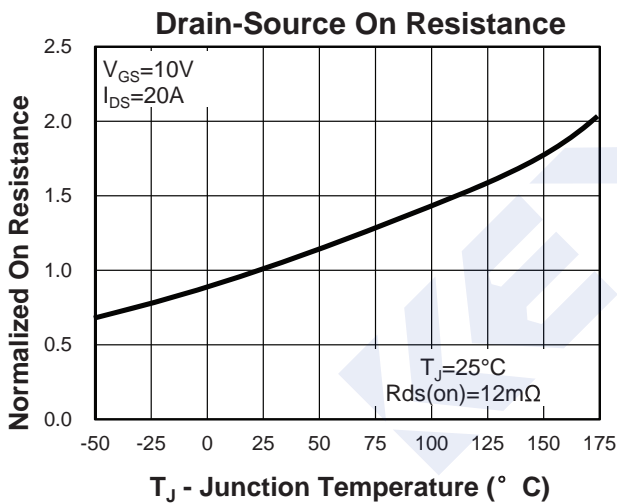
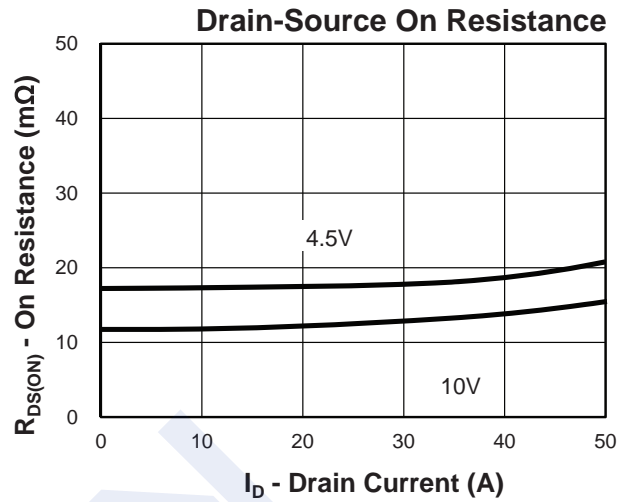
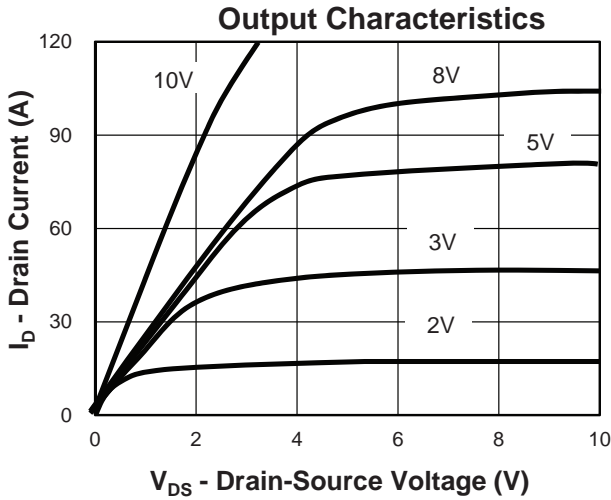
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■ Typical Characteristics ($T_J = 25^\circ\text{C}$ unless otherwise specified)

N-Channel Typical Characteristics

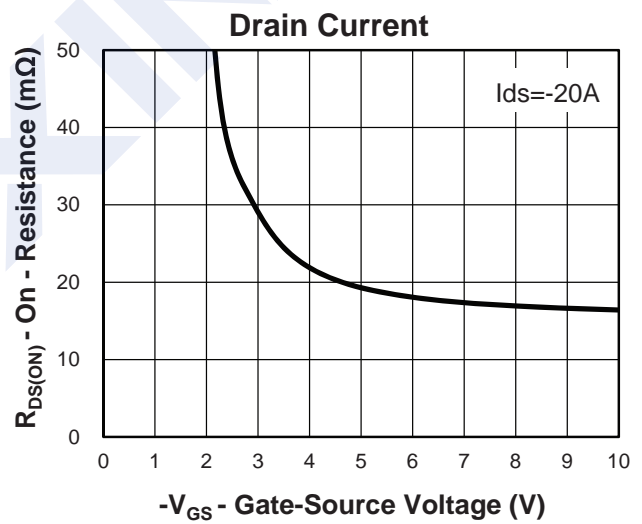
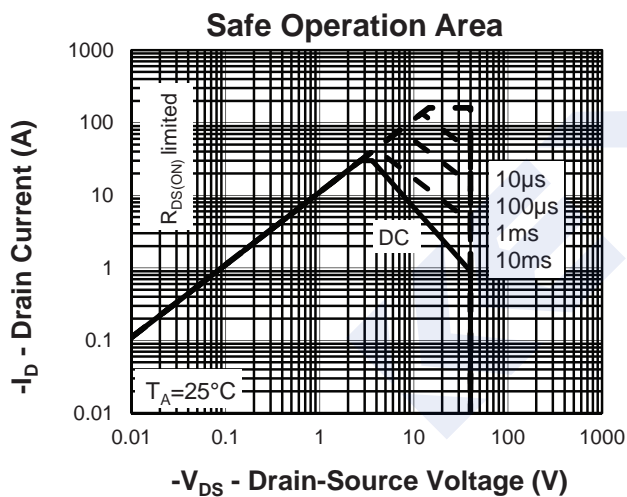
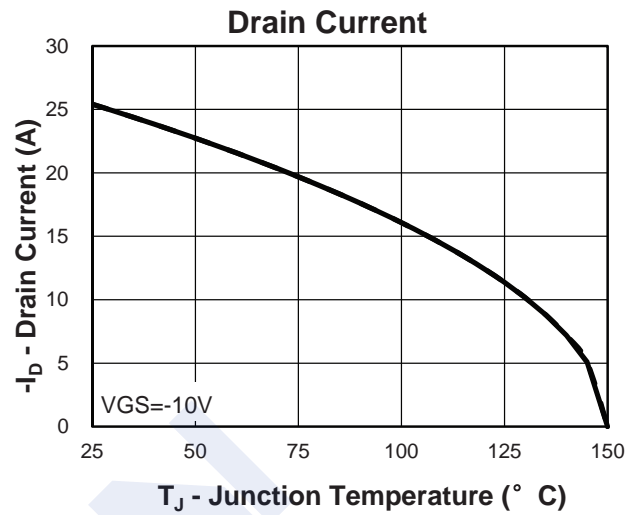
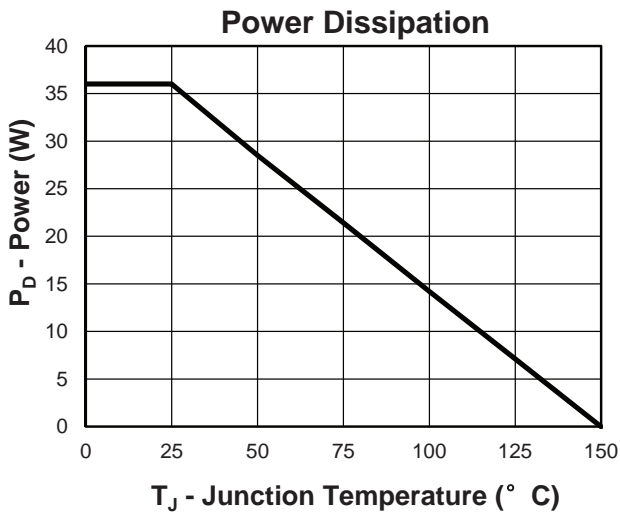


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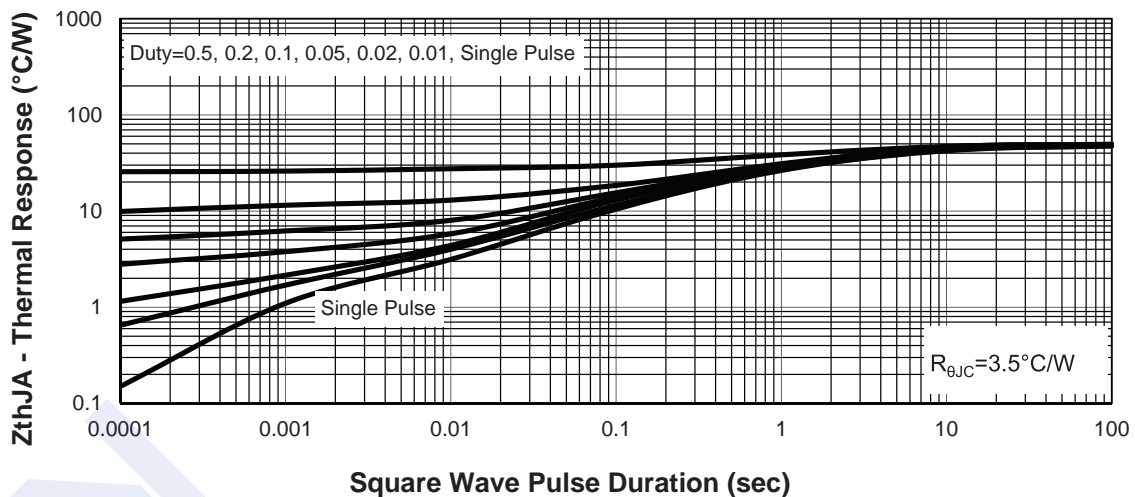


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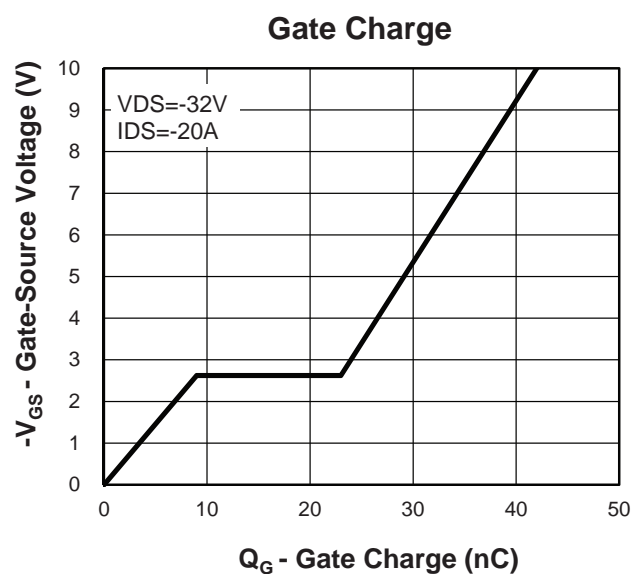
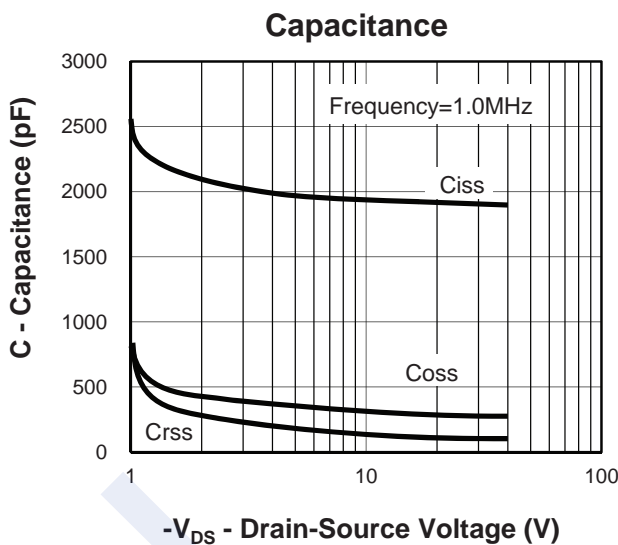
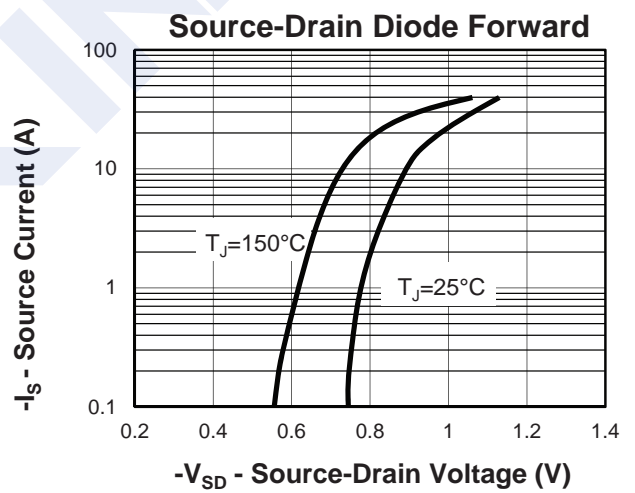
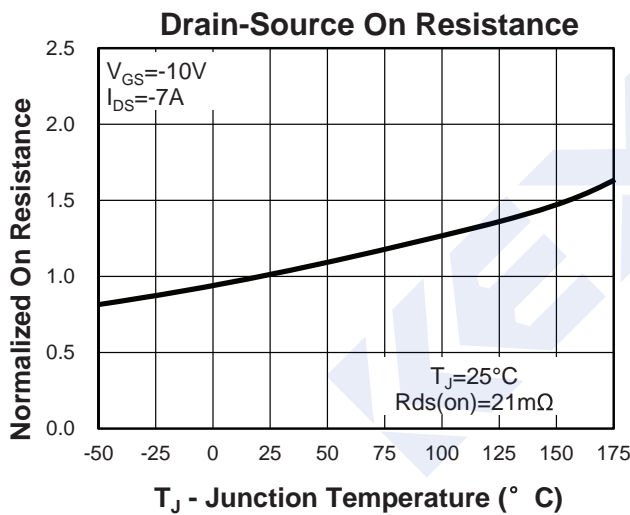
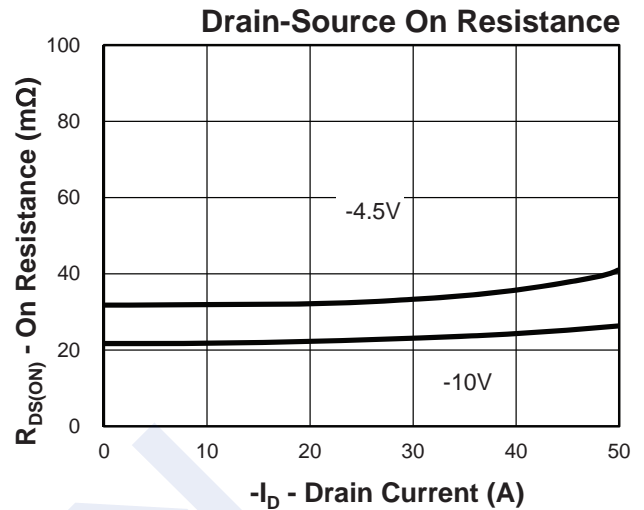
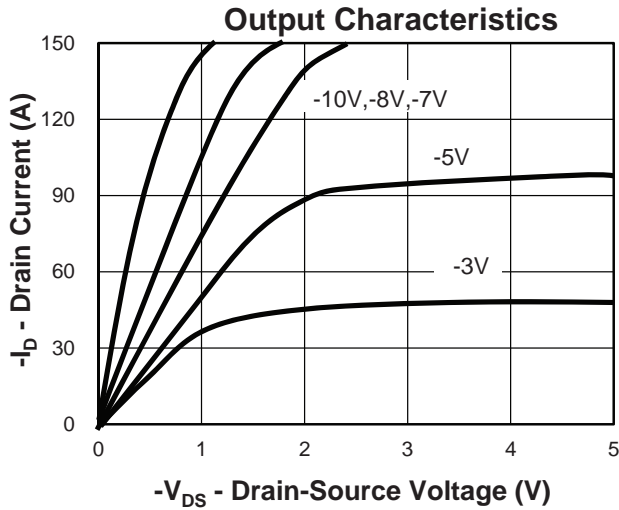
P-Channel Typical Characteristics



Thermal Transient Impedance

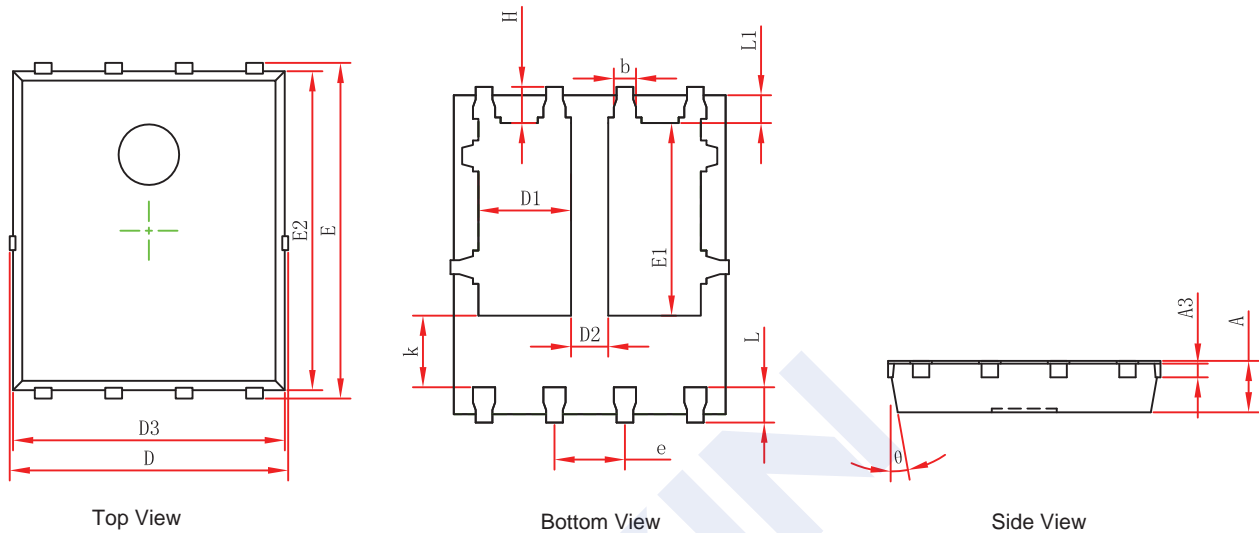


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■ PDFN5x6-8A Package Outline Dimensions



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	0.900	1.000	0.035	0.039
A3	0.254 REF.		0.010REF.	
D	4.944	5.096	0.195	0.201
E	5.974	6.126	0.235	0.241
D1	1.470	1.870	0.058	0.074
D2	0.470	0.870	0.019	0.034
E1	3.375	3.575	0.133	0.141
D3	4.824	4.976	0.190	0.196
E2	5.674	5.826	0.223	0.229
k	1.190	1.390	0.047	0.055
b	0.350	0.450	0.014	0.018
e	1.270TYP.		0.050TYP.	
L	0.559	0.711	0.022	0.028
L1	0.424	0.576	0.017	0.023
H	0.574	0.726	0.023	0.029
θ	10°	12°	10°	12°